PREFACE

It is my great pleasure to introduce you to the proceedings of 2018 The 7th International Conference on Engineering Mathematics and Physics (ICEMP 2018) which was held in Prague, Czech Republic on June 15-18, 2018.

ICEMP is an annual research conference aims to provide a platform for the scientists, scholars, engineers and students from the Universities all around the world and the industry to present ongoing research activities. The past 6 ICEMP conferences were held in Bangalore (India), Colombo (Sri Lanka), Hong Kong, Kuala Lumpur (Malaysia), and Dubai (UAE), and Cape Town (South Africa) respectively.

This volume consists of 20 selected papers from papers submitted to the conference from 16 countries and districts around the world including China, Russia, Mexico, India, Iran, Egypt, Thailand, Germany, Korea, Oman, Indonesia, Ukraine, Colombia, Turkey, Saudi Arabia, and France. The proceedings cover a wide range of topics including Applied Mathematics and Physics, Material Physics and Performance Analysis. Each contributed paper was strictly double blind peer-reviewed by international reviewers who were drawn from the organizing committee members and other experts. All the papers are evaluated through six aspects, i.e., relevance to the conference, originality, appropriateness of the research method, innovation, significance, English presentation. All the papers were also presented and examined during the conference orally or with posters.

We would like to thank all authors who have contributed to this volume and also to our chairs, keynote speakers, invited speakers, reviewers and other conference participants for their support to ICEMP 2018.

We hope ICEMP 2018 will generate many new innovative trends in the field and also all the authors and other interested readers will find the proceedings useful for their academic and research work. Last but not least, we are looking forward to meeting you at ICEMP 2019.

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